

Rectifier Diode Modules AMKE 600



| V_{RSM} V | V_{RRM}, V_{DRM} V | $I_{FRMS} = 930$ A (maximum value for continuous operation) $I_{FAV} = 600$ A (sin. 180; $T_c = 100^\circ\text{C}$) | | |
|----------------|-------------------------|---|--|--|
| 1200 | 1200 | AMKE 600-12 | | |
| 1600 | 1600 | AMKE 600-16 | | |
| 2000 | 2000 | AMKE 600-20 H4 | | |
| 2200 | 2200 | AMKE 600-22 H4 | | |

| Symbols and parameters | | | Values | Units |
|------------------------|--|---|----------------------------|--|
| I_{FAV} | Mean forward current | sin 180; $T_c = 100^\circ\text{C}$ | 600 | A |
| I_{FSM} | Surge forward current | $T_{vj} = 25^\circ\text{C}; 10$ ms $T_{vj} = 150^\circ\text{C}; 10$ ms | 22000 18000 | A A |
| i^2t | i^2t value, rating for fusing | $T_{vj} = 25^\circ\text{C}; 8.3...10$ ms $T_{vj} = 150^\circ\text{C}; 8.3...10$ ms | 2420000 1805000 | A^2s A^2s |
| V_F | Forward voltage | $T_{vj} = 25^\circ\text{C}; I_F = 3000$ A | max. 1.5 | V |
| $V_{(TO)}$ | On-state threshold voltage | $T_{vj} = 150^\circ\text{C}$ | max. 0.75 | V |
| r_T | On-state slope resistance | $T_{vj} = 150^\circ\text{C}$ | max. 0.25 | $\text{m}\Omega$ |
| I_{RD} | Direct reverse current | $T_{vj} = 150^\circ\text{C}; V_{RD} = V_{RRM}$ | max. 15 | mA |
| $R_{th(j-c)}$ | Thermal resistance, junction to case | cont.; per diode = per module sin.180; per diode = per module | 0.07 0.075 | K/W K/W |
| $R_{th(c-s)}$ | Thermal resistance, junction to heatsink | per diode = per module | 0.02 | K/W |
| T_{vj} | (Virtual) junction temperature | | -40 ... +150 | $^\circ\text{C}$ |
| T_{stg} | Storage temperature range | | -40 ... +130 | $^\circ\text{C}$ |
| V_{isol} | Insulation test voltage (r.m.s.) | a.c. 50 Hz; r.m.s.; 1s / 1min. a.c. 50 Hz; r.m.s.; 1s / 1min. for AMKE...H4 | 3600 / 3000 4800 / 4000 | V~ V~ |
| M_s | Mounting torque on heatsink | | $5 \pm 15\%$ | Nm |
| M_t | Mounting torque for terminals | | $17 \pm 15\%$ | Nm |
| a | Maximum allowable acceleration | | $5 \cdot 9.81$ | m/s^2 |
| W | Weight | | 840 | g |

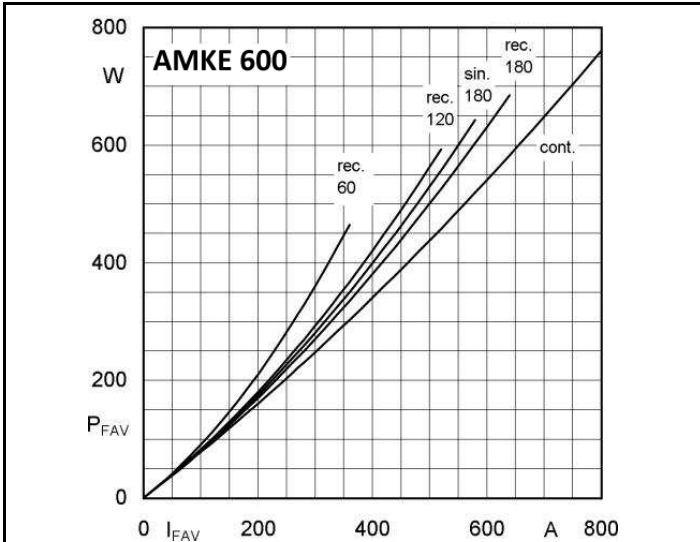


Fig. 11L Power dissipation per diode vs. forward current

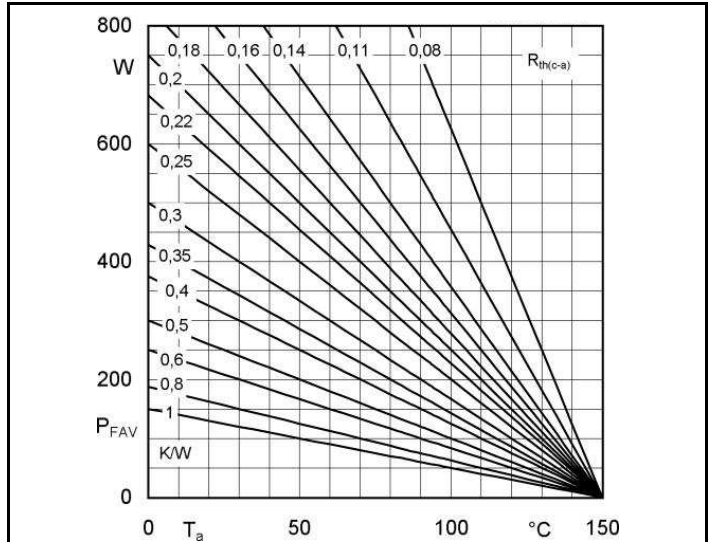


Fig. 11R Power dissipation per diode vs. ambient temperature

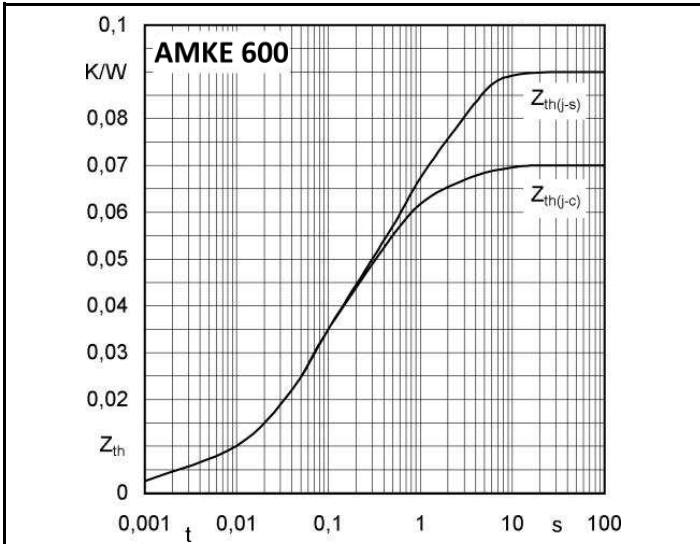


Fig. 14 Transient thermal impedance vs. time

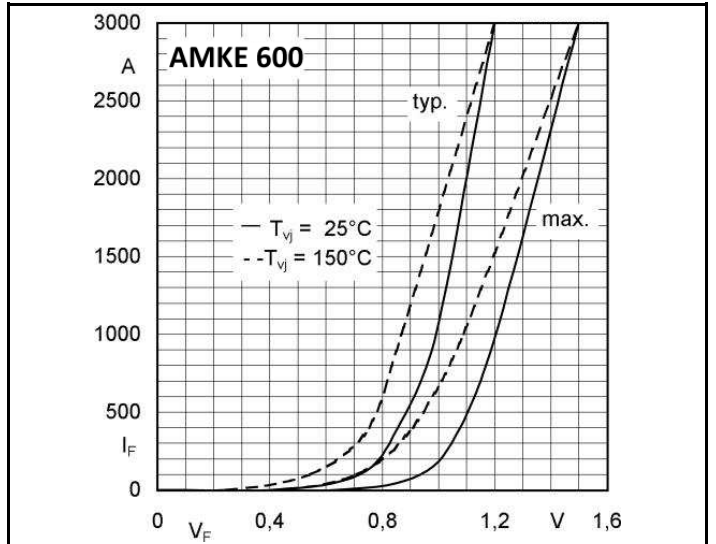


Fig. 15 Forward characteristics

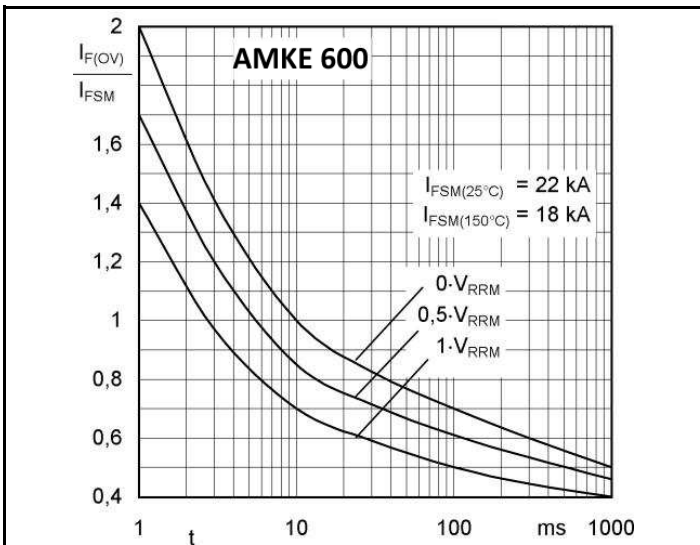
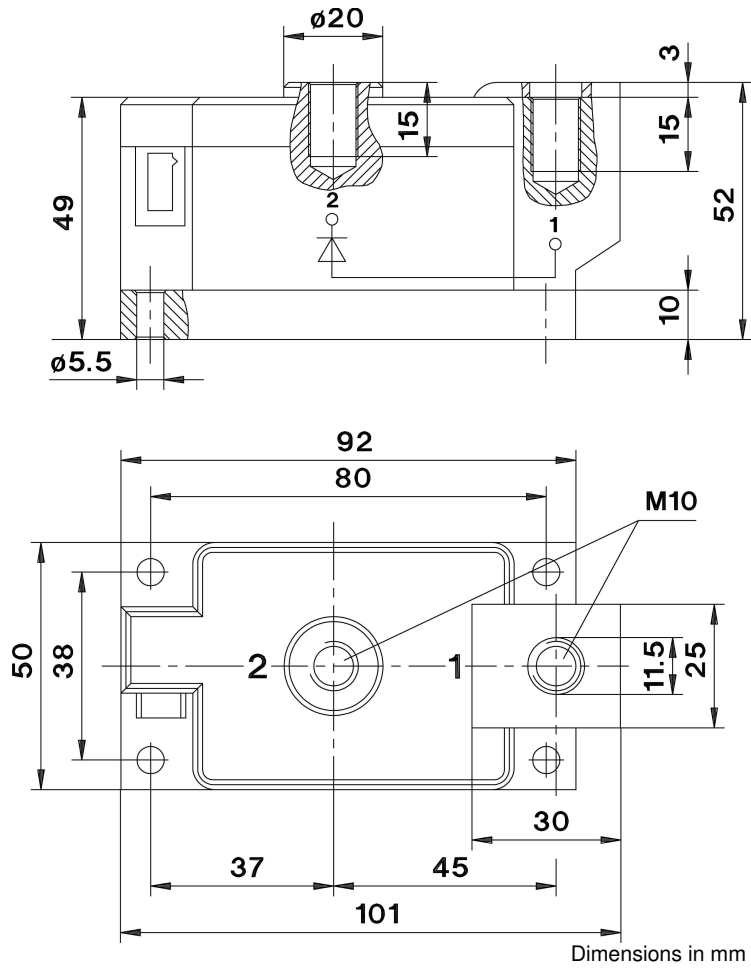


Fig. 16 Surge overload current vs. time

DIMENSIONS



TOPOLOGY OF INTERNAL CONNECTION

